Overview



- 1. 3 External 5.25" bays; in top to bottom order:
 - HP Z220 CMT handle (optional)
 - DVD-RW optical drive (optional)
 - 22-in-1 Media Card Reader (optional)
- 2. Power button
- 3. Front I/O (in top to bottom order): 1 USB 2.0 port, 2 USB 3.0 (blue) ports, Headphone, Microphone, optional IEEE 1394a port.

Form Factor	Convertible Minitower
Form Factor Operating Systems	Preinstalled: Genuine Windows® 7 Ultimate 64-Bit Genuine Windows® 7 Professional 32/64 Genuine Windows® 7 Home Premium 32/64 HP Installer Kit for Linux [includes drivers for 64-bit OS versions of Red Hat Enterprise Linu 6 and SUSE Linux Enterprise Desktop (SLED) 11] SUSE Linux Enterprise Desktop 11 64-bit Red Hat Enterprise Linux Workstation (1 year paper license available; Preinstall not available) Supported: Genuine Windows® 7 Enterprise 32/64 Genuine Windows® XP Professional 32/64 (on select configurations)*
	* See the "Windows XP Support Matrix for Z Workstations" at: http://www.hp.com/support/workstation_manuals NOTES: For detailed OS/hardware support information for Linux, see:

Overview

http://www.hp.com/support/linux hardware matrix

		TILLD.// W	ww.np.com/sup	Jport/III iu	<u></u>	_matrix			
Name	Cores	Clock Speed (GHz)	Intel® Turbo Boost Technology ¹	Cache (MB)	Memory Speed (MHz)	Hyper- Threading	Integrated Graphics	Featuring Intel® vPro™ Technology	TDP (W)
Intel® Xeon®									
processor E3-1290v2	4	3.7	4.1	8	1600	Y	N/A	Y	87W
Intel® Xeon®									
processor E3-1280v2	4	3.6	4.0	8	1600	Y	N/A	Y	69W
Intel® Xeon®		2.5	2.0		4000	V	NI/A	V	CO)A/
processor E3-1270v2	4	3.5	3.9	8	1600	Y	N/A	Y	69W
Intel® Xeon® processor	4	3.4	3.8	8	1600	Y	Intel HD Graphics	Υ	77W
E3-1245v2	-	-					P4000		
Intel® Xeon® processor E3-1240v2	4	3.4	3.8	8	1600	Y	N/A	Y	69W
Intel® Xeon® processor E3-1230v2	4	3.3	3.7	8	1600	Y	N/A	Y	69W
Intel® Xeon® processor E3-1225v2	4	3.2	3.6	8	1600	N	Intel HD Graphics P4000	Y	77W
Intel® CoreTM i7- 3770 processor	4	3.4	3.9	8	1600	Y	Intel HD Graphics 4000	Υ	77W
Intel® Pentium® G640 processor	2	2.8	N/A	3	1066	N	Intel HD Graphics	N	65W

¹The specifications shown in this column represent the maximum turbo frequency with one core active. Turbo boost steppiloccurs in 100MHz increments. Processors that do not have turbo functionality are denoted as N/A.

Available Processor Disclaimers

Integrated Intel® HD graphics is not supported on the Intel Xeon processor E3-1230v2, E3-1240v2, E3-1270v2, E3-1280v2 or E3-1290v2.

Intel® Xeon E3, Intel Core i3 and Intel Pentium processors can support either ECC or non-ECC memory; Intel® Core i5/i7 processors only support non-ECC memory.

Intel's numbering is not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. See: http://www.intel.com/products/processor number/ for details.

64-bit computing on Intel® 64 architecture requires a computer system with a processor, chipse BIOS, operating system, device drivers and applications enabled for Intel 64 architecture. Processor will not operate (including 32-bit operation) without an Intel 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. See: http://www.intel.com/info/em64t for more information.

Dual-Core and Quad-Core technologies are designed to improve performance of multithreaded software products and hardware-aware multitasking operating systems and may require appropriate operating system software for full benefits; check with software provider to determine suitability; Not all customers or software applications will necessarily benefit from use of these technologies.

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Convertibility Yes. 5.25" drives rotate for Minitower or Desktop orientation.

Expansion Slots (see system board section for more details)

1 PCIe Gen3 x16 slot

system board section for 1 PCIe Gen2 x4 slot /x16 connector

1 PCIe Gen2 x4 slot /x8 connector

2 PCIe Gen 2 x1 slot

2 PCI slots



Overview

	NOTE: The PCIe x8 connector is open ended, allowing a PCIe x16 card to be seated in the slot.
	However, this slot supports only half length cards.
	In the PCle Gen3 x16 slot, if it is not being used for a graphics card, only cards certified as After
	Market Options for this platform are supported.
Expansion Bays (see	3 internal 3.5" bays
storage section for more	3 external 5.25" bays
details)	NOTE: Third external 5.25" bay is not full depth; maximum depth 170 mm (6.7 inches)
Front I/O	2 USB 3.0, 1 USB 2.0, 1 IEEE 1394a (requires optional PCIe card to function), 1 Headphone, an 1 Microphone.
Internal I/O	5 USB 2.0 ports available by two separate 2x5 and one 1x5 header:
	supports one HP Internal USB Port Kit (one port on each Kit) for 1x5 pin header plus
	(a) up to two USB Media Card Readers, or (b) one Internal Port kit and one USB Media Card
	Reader.
Rear I/O	1 DVI-I Single Link and 1 DisplayPort output from Intel HD graphics (available on selected
	processors only),
	2 USB 3.0, 4 USB 2.0, 1 optional serial port, 2 PS/2, RJ-45 (NIC), 1 Audio Line-in, 1 Audio Line-
	out, 1 Microphone; 2 IEEE 1394b ports (optional)
Interfaces Supported	22-in-1 Media Card Reader (optional)
Chassis Dimensions	Standard minitower orientation: 447 x 178 x 455 mm (17.6 x 7 x 17.9 in); Converted desktop
(H x W x D)	orientation: 178 x 447 x 455 mm (7 x 17.6 x 17.9 in)
Weight	Exact weights depend upon configuration:
_	Minimum: 10.4 :kg (22.9 lbs)
	Typical*: 11.6 kg (25.5 lbs) Maximum: 14.8 kg (32.6 lbs)
	Max Supported Weight (desktop orientation) 35 kg (77 lb)
	* Typical weight when configured with 1 3.5" hard drive, 1 optical drive, 2 DIMMs and 1 NVIDIA
	NVS 300 graphics card
Temperature	Operating: 40° to 95°F (5° to 35°C)
	Non-operating: -40° to 140°F (-40° to 60°C)
Humidity	Operating: 8% to 85%
-	Non-operating: 8% to 90%
Maximum Altitude (non-	Operating: 3,000 m; 10,000 ft
pressurized)	Non-operating: 9,100 m; 30,000 ft
Power Supply	400 watts wide-ranging, active Power Factor Correction, 90% Efficient
,	The Power Supply Efficency Report for this Power Supply may be found at the following link:
	http://www.plugloadsolutions.com/psu_reports/HEWLETT-PACKARD_619397-
	001 ECOS%202277%201 400W Report.pdf
Backup Devices	For a complete listing of compatible DAT tape drives, LTO tape drives and RDX Removable Disk
•	Backup System offerings, please visit: http://www.hp.com/go/connect
Chipset	Intel® C216 chipset
Memory	4 DIMM slots, supporting up to 32GB ECC/non-ECC, DDR3 1600 MHz
Memory disclaimers	The CPUs determine the speed at which the memory is clocked. If a 1066 MHz capable CPU is
j aleelallilei	used in the system, the maximum speed the memory will run at is 1066 MHz regardless of the
	specified speed of the memory.
Workstation ISV	See the latest list of certifications at
Certifications	http://www.hp.com/united-states/campaigns/workstations/partnerships.html
- Co. tilloutions	properties of the desired of the constant of t



Supported Components

Processors

	Factory Configured	Option Kit	Option Kit Part Support Number Notes
Intel® Xeon® processor E3 v2 family (Z220)			
Intel® Xeon® processor E3-1290v2, Quad-Core, 8 MB cache, 3.7 GHz, up to 4.1 GHz with Intel Turbo Boost Technology	Υ	N	See Note 2
Intel® Xeon® processor E3-1280v2, Quad-Core, 8 MB cache, 3.6 GHz, up to 4.0 GHz with Intel Turbo Boost Technology	Υ	N	See Note 2
Intel® Xeon® processor E3-1270v2, Quad-Core, 8 MB cache, 3.5 GHz, up to 3.9 GHz with Intel Turbo Boost Technology	Υ	N	See Note 2
Intel® Xeon® processor E3-1245v2, Quad-Core, 8 MB cache, 3.4 GHz, up to 3.8 GHz with Intel Turbo Boost Technolo	Υ	N	See Note 2
Intel® Xeon® processor E3-1240v2, Quad-Core, 8 MB cache, 3.4 GHz, up to 3.8 GHz with Intel Turbo Boost Technology	Υ	N	See Note 2
Intel® Xeon® processor E3-1230v2, Quad-Core, 8 MB cache, 3.3 GHz, up to 3.7 GHz with Intel Turbo Boost Technology	Υ	N	See Note 2
Intel® Xeon® processor E3-1225v2, Quad-Core, 8 MB cache, 3.2 GHz, up to 3.6 GHz with Intel Turbo Boost Technology	Υ	N	See Note 2
3rd generation Intel® Core™ processor family			
Intel® Core™ i7-3770 processor, Quad-Core, 8 MB cache, 3.4GHz, up to 3.9 GHz with Intel Turbo Boost Technology	Υ	N	See Note 3
Dual-Core Intel Pentium processors (Z220)			
Intel® Pentium® G640 processor, Dual-Core, 3 MB cache, 2.8 GHz	Υ	N	See Note 2

NOTE 1: Intel HD Graphics P4000 supports workstation-specific graphics drivers for improved compatibility and performance on select professional applications, compared to either Intel HD Graphics 4000 or Intel HD Graphics 2500.

NOTE 2: These processors support either ECC or non-ECC memory

NOTE 3: These processors support only non-ECC memory



Supported Components

Monitors / Displays			Option	
	Factory	Option	Kit Part	Support
	Configured	Kit	Number	Notes

HP DreamColor LP2480zx Professional Display

HP ZR30w 30-inch S-IPS LCD Monitor

HP ZR2740w 27-inch LED Backlit IPS Monitor

HP ZR24w 24-inch S-IPS LCD Monitor

HP ZR2440w 24-inch LED Backlit IPS Monitor

HP ZR2240w 21.5-inch LED Backlit IPS Monitor

HP ZR2040w 20-inch LED Backlit IPS Monitor

Supported by all Operating Systems available from HP

Screen Size Diagonally Measured

Hard Drives

SATA Hard Drives		Factory Configured	Option Kit	Option Kit Part Supp Number Note	
	SATA (Serial ATA) Hard Drives for HP Workstat	ions			
	250GB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ034AA	
	500GB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ036AA	
	1TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ037AA	
	2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	QB576AA	
	300GB SATA 10K rpm SFF in 3.5" Frame HDD	Υ	Υ	FM802AA	
SATA Solid State	HP Solid State Drives (SSDs) for Workstations				
Drives	HP 160GB SATA SSD	Υ	Υ	LZ704AA	
	HP 300GB SATA SSD	Υ	Υ	LZ069AA	
	HP 128GB SATA SSD	Υ	Υ	A3D25AA	
	HP 256GB SATA SSD	Υ	Υ	A3D26AA	
	Intelligent Disk Caching				
	24GB SSD Disk Cache Module	Υ	Υ		



Supported Components

Hard Drive Controllers		Factory Configured	Option Kit	Option Kit Part Support Number Notes
	Integrated SATA Controller (Z220)			
	Integrated SATA Controller (CMT), RAID 0,1 supported: 4 ports 3 Gb/s, 2 ports 6 Gb/s	Y	N	
	Factory integrated RAID on motherboard for S	SATA drives		
	RAID 0 Data Configuration Boot/OS Drive + 2 Drive Striped Array	Y	N	
	RAID 0 Configuration - Striped Array	Υ	N	
	RAID 1 Configuration - Mirrored Array	Υ	N	
	SATA hardware RAID is not supported on Linux s software RAID, provides excellent functionality and hardware-based RAID. All drives must be identical Boot volume/RAID array must be less than 2 TB.	d performance. I	t is a goo	

NOTE 1: Requires identical hard drives (speeds, capacity, interface).

Graphics		Factory Configured	Option Kit	Option Kit Part Number	Support Notes	Support Multi Mixed
	egrated Intel HD Graphics Media Acco	•	•			
Inte	el HD Graphics P4000	Y	N		Supported on Intel Xeon E3- 12X5v2 processors	1
Inte	el HD Graphics 4000	Y	N		Supported on Intel Core i7- 3770 processors	1
Inte	el HD Graphics	Y	N		Supported on Intel Pentium G6xx processors	1
Pro	ofessional 2D					
NV Car	IDIA NVS300 512MB PCIe Graphics rd	Υ	Υ	XP612AA		2
	IDIA NVS 310 512MB Graphics Card	Υ	Υ	A7U59AA		2
	ID FirePro V4900 1GB Graphics Card	Υ	Υ	A3J92AA		1
AM	ID FirePro V3900 1GB Graphics Card	Υ	Υ	A6R69AA		1
NV	IDIA Quadro 600 1GB Graphics Card	Υ	Υ	WS093AA		1
NV	IDIA Quadro 410 512MB Graphics	Υ	Υ	A7U60AA		1
Mic	d-range 3D					
AM	ID FirePro V5900 2GB Graphics	Υ	Υ	LS992AA		1
	IDIA Quadro 2000 1GB Graphics Card Jh End 3D	Υ	Υ	WS094AA		1
NV	IDIA Quadro 4000 2GB Graphics Card	N	Υ	WS095AA		1
AM	ID FirePro V7900 2GB Graphics	N	Υ	LS993AA		1



Supported Components

Intermixing integrated Intel HD graphics and discrete graphics cards in order to drive more than two displays can be enabled using the Computer (F10) Setup Utility. However, HP recommends using only discrete graphics cards when attaching three or more displays.

Memory

Sub-Section Description/Notes

Intel® Xeon E3, Intel Core i3 and Intel Pentium processors can support either ECC or non-ECC memory; Intel® Core i5/i7 processors only support non-ECC memory.

CTO Option Kit Part Support Notes
Number

DDR3-1600 nECC Unbuffered DIMMs CTO

HP 32GB (4x8GB) DDR3-1600 nECC RAM

HP 16GB (4x4GB) DDR3-1600 nECC RAM

HP 12GB (2x4GB+2x2GB) DDR3-1600 nECC RAM

HP 8GB (2x4GB) DDR3-1600 nECC RAM

HP 8GB (4x2GB) DDR3-1600 nECC RAM

HP 4GB (2x2GB) DDR3-1600 nECC RAM

HP 2GB (1x2GB) DDR3-1600 nECC RAM

DDR3-1600 ECC Unbuffered DIMMs - CTO

HP 32GB (4x8GB) DDR3-1600 ECC RAM

HP 16GB (4x4GB) DDR3-1600 ECC RAM

HP 12GB (2x4GB+2x2GB) DDR3-1600 ECC RAM

HP 8GB (2x4GB) DDR3-1600 ECC RAM

HP 8GB (4x2GB) DDR3-1600 ECC RAM

HP 4GB (2x2GB) DDR3-1600 ECC RAM

HP 2GB (1x2GB) DDR3-1600 ECC RAM

Sub-Section Description/Notes

Two channels of DDR3 memory are supported. To realize full performance at least one DIMM must be inserted into each channel.

The CPUs determine the speed at which the memory is clocked. If a 1066 MHz capable CPU is used in the system, the maximum speed the memory will run at is 1066 MHz regardless of the specified speed of the memory.

АМО	Option Kit Part Number	Support Notes
DDR3-1600 nECC Unbuffered DIMMs AMO		
HP 8GB (1x8GB) DDR3-1600 non-ECC RAM	B1S54AA	
HP 4GB (1x4GB) DDR3-1600 nECC RAM	B1S53AA	
HP 2GB (1x2GB) DDR3-1600 nECC RAM	B1S52AA	
DDR3-1600 ECC Unbuffered DIMMs - AMO		
HP 8GB (1x8GB) DDR3-1600 ECC RAM		
HP 4GB (1x4GB) DDR3-1600 ECC RAM		
HP 2GB (1x2GB) DDR3-1600 ECC RAM		
NOTE: Only unbuffered DDR3 DIMMs are supported		



Supported Components

Multimedia and Audi	0				
Devices			•	Kit Part	• •
		Configured	Kit	Number	Notes
	HP Thin USB Powered Speakers, BFR-PVC free	Y	Υ	KK912AA	
	Integrated Realtek HD ALC221 Audio	Υ	N		

Optical and Removable Storage		Factory Configured	Option Kit	Option Kit Part Support Number Notes
	HP 16X DVD-ROM SATA Drive (non Lightscribe)	Υ	Υ	AR629AA
	HP 16X DVD+/-RW SuperMulti SATA Drive (non- Lightscribe)	Y	Υ	QS208AA
	HP Blu-ray Writer	Υ	Υ	AR482AA
	HP 22-in-1 Media Card Reader Kit (Workstations)	Υ	Υ	NK361AA

Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

As Blu-ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

Controller Cards		Factory Configured	• • • • • • • • • • • • • • • • • • • •	Option Kit Part Number	Support Notes
	HP IEEE 1394b FireWire PCIe Card	Y	Υ	NK653AA	See Note 1
	HP USB 3.0 2x2 Port SuperSpeed PCIe x1 Card	N	Υ	QT587AA	See

NOTE 1: For the HP Z220 CMT Workstation the 1394b card is only supported on Slots 3, 4, or 5.

NOTE 2: Four USB 3.0 ports are available integrated on the motherboard (2 front, 2 rear). Integrated USB 3.0 ports are supported under Windows 7 operating system only. The USB 3.0 2x2 Port SuperSpeed PCIe card is required if Windows XP operating systems support is required (supported as AMO only).



Supported Components

Networking and Communications		Factory Configured	-	Option Kit Part Support Number Notes
	Integrated Intel 82579LM PCIe GbE Controller	Υ	N	
	Intel Gigabit CT Desktop NIC	Υ	Υ	
	Broadcom NetXtreme Gigabit Ethernet Plus NIC (PCIe)	N	Υ	FS215AA

NOTE 1: "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required. The Intel Gigabit CT NIC is supported on the following operating systems: Microsoft Windows XP Pro 32-bit and 64-bit and Microsoft Windows 7 32-bit and 64-bit versions.

Red Hat Enterprise Linux (RHEL), Novell SLED 11

NOTE 2: The integrated network connection is required to support Intel vPro Technology.

NOTE 3: If AMT is enabled network teaming with the built in LAN port is not possible.

NOTE 4: DASH remote manageability support is not available with the Broadcom NIC when used on the Z220 workstation.

Racking and Physical Security		Factory Configured	Option Kit	Option Kit Part Support Number Notes
	HP xw4/Z2/Z4 Depth Adjustable Fixed Rail Rack Kit	N	Υ	WH340AA
	Security Cable with Kensington Lock	N	Υ	PC766A
	HP Solenoid Hood Lock & Hood Sensor	Υ	Υ	DE618A
	HP Business PC Security Lock Kit	N	Υ	PV606AA

Input Devices		Factory Configured	Option Kit	Option Kit Part Support Number Notes
	HP SpacePilot 3D USB Intelligent Controller	N	Υ	EF390AA
	HP SpaceExplorer 3D USB Controller	N	Υ	RY429AA
	HP USB Optical 3-Button Mouse	Υ	Υ	DY651A
	HP 2.4GHz Wireless Keyboard & Mouse	N	Υ	NB896AA
	HP USB CCID SmartCard Keyboard	Υ	Υ	BV813AA
	HP USB 1000dpi Laser Mouse	Υ	Υ	
	HP PS/2 Keyboard	Υ	Υ	
	HP USB Optical Mouse	Υ	Υ	
	HP PS/2 Mouse	Υ	Υ	
	HP USB Keyboard	Υ	Υ	
	HP PS/2 Optical Scroll Mouse	Y	Υ	



Supported Components

Other Hardware		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Power Cord Kit	N	Υ	DM293A	
	HP Workstation Mouse Pad	Υ	N		Japan only
	HP Serial Port Adapter	Υ	Υ	PA716A	
	HP ENERGY STAR 5.0 Enabled Configuration	Υ	N		
	Configure minitower in desktop orientation	Υ	N		
	HP Parallel Port Adapter Kit	N	Υ	KD061AA	
	HP Internal USB Port Kit	N	Υ	EM165AA	
	HP eSATA PCI Cable Kit	Υ	Υ	FH966AA	

Software		Factory Configured	Option Kit	Option Kit Part Suppo Number Notes
	HP Performance Advisor	Y	N	Support Window 7 only Availabet as a downlo from hp.com pre- installe with ever Window 7 orde
	Roxio Easy Media Creator (DVD/Blu-ray Disc burner software)	Υ	N	
	Intervideo WinDVD (DVD player/burner software)	Υ	Ν	
	HP ProtectTools Security	Y	N	Availab Q3 20° Must be selected as a Configuent to Orded option Delivered in the form of "Drop the Bo CD.
	PDF Complete - Corporate Edition	Υ	Ν	
	HP Power Assistant HP Support Assistant	Y Y	N N	



Ν

Supported Components

MS Office Home & Business 2010

Υ

Must be ordered CTO.
Require user activatio

Operating Systems		Support Notes
	Genuine Windows® 7 Ultimate 64-bit	
	Genuine Windows® 7 Professional 32-bit	See http://www.microsoft.com/windows/windows-7. for support details.
	Genuine Windows® 7 Professional 64-bit	See http://www.microsoft.com/windows/windows-7. for support details.
	Genuine Windows® 7 Home Premium 32-bit	See http://www.microsoft.com/windows/windows-7. for support details.
	Genuine Windows® 7 Home Premium 64-bit	See http://www.microsoft.com/windows/windows-7. for support details.
	HP Linux Installer Kit	See http://h20331.www2.hp.com/hpsub/cache/537200-0-0 225-121.html
	Red Hat Enterprise Linux (RHEL) Workstation - Paper License (1yr)	See http://www.redhat.com/rhel/desktop/
	SUSE Linux Enterprise Desktop 11	See http://www.suse.com/products/desktop/
	Windows XP 32-bit/64-bit OS supported: d	rivers available on HP support web site.

System Board					
System Board Form Factor	ATX 244 x 305 mm (9.6 x 12 inches)				
Processor Socket	Single LGA-1155				
CPU Bus Speed	DMI				
Chipset	ntel® PCH C216				
Memory Expansion Slots	1 DDR3 memory slots				
Memory Type Supported	DDR3, UDIMM (Unbuffered), ECC& non-ECC				
Memory Modes	Non-Interleaved for single channel. In	terleaved when both channels are populated.			
Memory Speed Supported	1600MHz DDR3				
Memory Protection	ECC available on data				
Maximum Memory	32GB				
Memory Configuration (Supported)	2GB,4GB and 8GB ECC or non-ECC unbuffered DIMMs are supported. ECC and non-ECC memory DIMMs cannot be mixed on the same system. NOTE: Maximum memory capacities assume 64-bit operating systems, such as genuine				
	Genuine Windows® 7 Professional 64-Bit or Red Hat Linux 64-bit. 32-bit Windows Operating Systems support up to 4 GB.				
PCI Express Connectors	- 1 PCI Express Gen2 slot x8 mechanical/ x4 electrical (full height, half length) - 1 PCI Express Gen3 slot x16 mechanical/ x16 electrical (full height, full length) - 1 PCI Express Gen2 slot x1 mechanical/ x1 electrical (full height) - 1 PCI Express Gen2 slot x16 mechanical/ x4 electrical (full height, full length) - 1 PCI Express Gen2 slot x1 mechanical/ x1 electrical (full height) NOTE: The PCIe x8 connector is open ended, allowing a PCIe x16 card to be seated in the slot. However, this slot supports only half length cards. In the PCIe Gen3 (x16 electrical/x16 mechanical) slot, if it is not being used for a graphics card, only cards certified as After Market Options for this platform are supported.				
PCI Connectors (5.0V)	2 PCI slots, full height, full length				
Supported Drive Interfaces	Integrated (6) Serial ATA interfaces (2x 6Gb/s SATA, 4x 3Gb/s SATA). One port can optionally be used for eSATA). RAID 0 and 1 supported. (Factory integrated RAID is Microsoft Windows only). RAID 5 is supported by Software XOR.				
	Serial Attached SCSI	None			
	Integrated RAID	NOTE: Requires identical hard drives (speeds, capacity, interface)			
	Integrated Graphics Integrated Intel HD Graphics (on Pentium G640 processor); Integrated Intel HD Graphics 4000 (on Core i7-3xxx processors); Integrated Intel HD Graphics P4000 (on Intel Xeon E3-12x5v2 processors).				
		Unified Memory Architecture (UMA)- A region of system memory is reserved and dedicated to the graphics display. Support for Microsoft DirectX 10.1; OpenGL 3.0 on Intel HD Graphics P4000; 1 DVI-I and 1 DP graphics ports integrated in motherboard; Supports dual displays across DP & DVI-I outputs.			



System rechilical d	Specifications	
	Network Controller	Integrated Gbit LAN MAC by Intel PHY Lewisville 82579LM. Management capabilities: WOL, PXE 2.1 and AMT 8
	External SATA (eSATA)	1 port eSATA capable (SATA 5) with optional eSATA After-Market Option cable kit.
	IDE connector	No
	Floppy connector	No
	Serial	1 internal header (requires optional Serial Port Adapter Kit)
	2nd Serial	No
	Parallel	1 internal header (optional Parallel Port Adapter required)
	HD Integrated Audio	Yes
	CD-ROM input (Audio)	No
	AUX input (Audio)	No
IEEE 1394 Connector(s)	Front	1 IEEE 1394a (requires optional PCIe 1394b card to function. Front port access functions as 1394a port).
	Rear	2 IEEE 1394b ports (requires optional PCle 1394b card)
	Internal	No
USB Connector(s)	Front	2 USB 3.0, 1 USB 2.0
	Rear	2 USB 3.0, 4 USB 2.0
	Internal	5 USB 2.0 ports available by two separate 2x5 and one 1x5 header: supports one HP Internal USB Port Kits, (one port on each Kit) for 1x5 pin header plus (a) up to two USB Media Card Readers, or (b) one Internal Port kit and one USB Media Card Reader.
HD Integrated Audio	Yes	
Flash ROM	Yes	
CPU Fan Header	Yes	
Chassis Fan Header	1 Rear System Chassis Fan Header	, 1 Optional Front Chassis Fan Header
Front Control Panel/Speaker Heade	Yes r	
CMOS Battery Holder - Lithium	Yes	
Integrated Trusted Platform Module	Integrated TPM 1.2. The TPM module disabled where res	stricted by law, i.e. Russia.
Power Supply Headers	Yes	
Power Switch, Power LED & Hard Drive LED Header		
Clear Password Jumper	Yes	
Keyboard/Mouse	USB or PS/2	
	400W Wide Ranging, Active PFC, 90	0% Efficient
Operating Voltage Range	90-269 VAC	
Rated Voltage Range	100-240 VAC	
Rated Line Frequency	50-60 Hz	

System Technical Specifications

On a matin or 1 in a	47.00 LIP
Operating Line Frequency Range	47-66 Hz
Rated Input Current	5.5A @ 100-240V
Heat Dissipation	Typical: 910 btu/hr (229 kg-cal/hr) Maximum: 1569 btu/hr (395 kg-cal/hr)
Power Supply Fan	92x25 mm variable speed
ENERGY STAR® qualified (Config Dependent)	Yes
80 PLUS Compliant	Yes, Gold. For the PSU Efficiency Report for the power supply, please go to this link: http://www.plugloadsolutions.com/psu_reports/HEWLETT-PACKARD_619397- 001_ECOS%202277%201_400W_Report.pdf
CECP Compliant @ 220V (<4W in S3 - Suspend to RAM)	Yes, Configuration dependent
FEMP Standby Power Compliant	Yes, with Wake-on-LAN disabled: <2W in S5- Power Off
Power consumption in sleep mode (as defined by ENERGY STAR) - Suspend to RAM (S3)	<4W
Built-in Self Test (BIST) LED	Yes
Surge Tolerant Full Ranging Power Supply (withstands power surges up to 2000V)	Yes
Hood Lock Header	Yes
ErP Lot 6- Tier 1 Compliance @ 230V (<1W in S5- Power Off)	Yes
ErP Lot 6- Tier 2 Compliance @ 230V (<0.5W in S5- Power Off)	Yes
Declared Noise Emissions (Entry-level and High-end configurations)	

System Configuration

Example Configuration #1	To be advised later with the Intel Core i3 processor introduction.				
Example	Processor Info	1x Intel Xeon E3-1280v2 3.6 8MB 4C HT 69W GT0 CPU			
Configuration #2	Memory Info	4GB (2x 2GB) 1600 MHz DDR3 ECC			
	Graphics Info	1x NVIDIA Quadro 600 1GB Graphics			
	Disks/Optical/Floppy	2x SATA 2 TB 7.2k rpm/ 2 Optical			
	PSU	400W 90%			
	OS /BIOS	Win7 64/v 0.9			



Energy Consumption		115	VAC	230	VAC	100	VAC	
						LAN Enabled LAN Disabled		
	Windows Idle (S0)	48.	 2 W	49.5 W		48.3 W		
	Windows Busy Typ (S0)	155.	.7 W	158.	158.8 W		155.6 W	
	Windows Busy Max (S0)	180.	5 W	183.8 W		184.7 W		
	Sleep (S3)	2.73 W	2.96W	2.95 W	2.80 W	2.69 W	2.55 W	
	Off (S5)	1.15 W	1.00 W	1.27 W	1.10 W	1.15 W	1.00W	
	Zero Power Mode (EuP)	0.2	3W	0.3	4 W	0.2	4W	
Heat Dissipation**		115	VAC	230	VAC	100 VAC		
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
	Windows Idle (S0)	164.5	btu/hr	168.9	btu/hr	164.8	btu/hr	
	Windows Busy Typ (S0)	531.2	btu/hr	541.8	btu/hr	530.9	btu/hr	
	Windows Busy Max (S0)	615.9	btu/hr	627.1 btu/hr		630.2 btu/hr		
	Sleep (S3)	9.31 btu/hr	10.10 btu/hr	10.07 btu/hr	9.55 btu/hr	9.18 btu/hr	8.70 btu/hr	
	Off (S5)	4.47 btu/hr	3.41 btu/hr	4.33 btu/hr	3.75 btu/hr	3.92 btu/hr	3.41 btu/hr	
	Zero Power Mode (EuP)	0.78	btu/hr	1.16	btu/hr	0.82	btu/hr	

Example	Processor Info	1x Intel Xeon E3-1280v2 3.6 8MB 4C HT 69W GT0 CPU
Configuration #3	Memory Info	32GB (4x 8GB) 1600 MHz DDR3 ECC
	Graphics Info	1x NVIDIA Quadro 600 1GB Graphics
	Disks/Optical/Floppy	3x SATA 2 TB 7.2k rpm/ 2 Optical
	PSU	400W 90%
	OS /BIOS	Win7 64/v 0.9

Energy Consumption		115	VAC	230	VAC	100	VAC
3, 11, 11							LAN Disabled
	Windows Idle (S0)	65.	3 W	64.3	3 W	64.4	4 W
	Windows Busy Typ (S0)	185.	7 W	194.0 W		181.2 W	
	Windows Busy Max (S0)	260.			258.6 W 20		5 W
	Sleep (S3)	3.57 W	3.34 W	3.67W	3.52 W	3.49 W	3.33 W
	Off (S5)	1.15 W	0.98 W	1.28 W	1.14 W	1.13 W	0.98 W
	Zero Power Mode (EuP)	0.2	2 W	0.30	6 W	0.2	1W
Heat Dissipation**		115 VAC 230 V		VAC	100	VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	222.8	btu/hr	219.4	btu/hr	219.7	btu/hr
	Windows Busy Typ (S0)	633.6	btu/hr	661.9	btu/hr	618.3	btu/hr
	Windows Busy Max (S0)	888.1	btu/hr	882.3	btu/hr	899.1	btu/hr
	Sleep (S3)	12.18 btu/hr	11.39 btu/hr	12.52 btu/hr	12.01 btu/hr	11.91 btu/hr	11.36 btu/hr

System Technical Specifications

Off (S5)	3.92 btu/hr	3.34btu/hr	4.37	btu/hr	3.89 btu/h	r 3.86	btu/hr	3.34 btu/hr
Zero Power Mode (EuP)	0.75	btu/hr		1.23	btu/hr		0.72	btu/hr

NOTES:

This product is in compliance with US executive order 13221, WOL (wake on LAN) disabled.

Declared Noise Emissions (Entry-level and High-end configurations)			
	Processor Info	Intel Core i7-3770 3.4 GHz	
	Memory Info	2 x 2GB DDR3 1600 MHz	
	Graphics Info	Integrated Intel HD Graphics 4000	
	Disks/Optical	1x 250 GB 7200rpm SATA HDD/ SATA DVD-ROM	

Declared Noise Emissions (in		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
accordance with ISO 7779 and ISO 9296)	Idle	3.2	13
	Hard drive Operating (random reads)	3.3	15
	DVD-ROM Operating (sequential reads)	4.99	35

System Configuration	Processor Info	Intel Xeon E3-1290v2 3.7 GHz
(High-end)	Memory Info	4 x 4GB DDR3 1600 MHz
	Graphics Info	NVIDIA Quadro 2000
1		2x 300GB 10K rpm SATA HDDs/ SATA Blu-ray ODD

Declared Noise Emissions (in		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
7779 and ISO 9296)	Idle	3.4	20
	Hard drive Operating (random reads)	3.7	23
	DVD-ROM Operating (sequential reads)	4.93	34

^{*} Energy Star low energy mode

^{**} Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Environmental Requirements	Temperature	Operating: 40° to 95° F (5° to 35° C) Non-operating: -40° to 140° F (-40° to 60° C)
	Humidity	Operating: 8% to 85% RH, non-condensing Non-operating: 8% to 90% RH, non-condensing
	Maximum Altitude	Operating: 3,000 m (10,000 ft) Non-operating: 9,100 m (30,000 ft)
	Dynamic (new)	Shock Operating: ½-sine: 40g, 2-3ms Non-operating: ½-sine: 160 cm/s, 2-3ms (~100g) square: 422 cm/s, 20g
		Vibration Operating random: 0.5g (rms), 5-300 Hz Non-operating random: 2.0g (rms), 10-500 Hz NOTES: Values represent individual shock events and do not indicate repetitive shock events. Values do not indicate continuous vibration.
	Cooling	Above 1524 m (5,000 ft) altitude, maximum operating temperature is de-rated by 1.8° F (1° C) per 305 m (1000 ft) elevation increase

Physical Securit	ty and Serviceability
Access Panel	Tool-less Includes system board and memory information
Optical Drive	Tool-less
Hard Drives	Tool-less
Expansion Cards	Tool-less
Processor Socket	Tool-less
Green User Touch Points	Yes, on tool-free internal chassis mechanisms
Color-coordinated Cables and Connectors	Yes
Memory	Tool-less
System Board	Screw-In
Dual Color Power and HD LED on Front of Computer	Yes
Configuration Record SW	Yes
Over-Temp Warning on Screen	Yes
Restore CD/DVD Set	Restores the system to the factory shipped operating system. Included with the system and available from HP Support
Dual Function Front Power Switch	Yes, causes a fail-safe power off when held for 4 seconds
Padlock Support	Yes (optional): Locks side cover and secures chassis from theft 0.22-in diameter padlock loop at rear of system



	,	
Cable Lock Support	Yes, Kensington Cable Lock (optional): Locks side cover and secures chassis from theft 3 mm x 7 mm slot at rear of system	
Universal Chassis Clamp Lock Support	Yes (optional): Locks side cover and locks cables to chassis. Secures chassis from theft and allows multiple units to be chained together when used with optional cable Threaded feature at rear of system	
Solenoid Lock and Hood Sensor	Yes (optional) The Solenoid Hood Lock eliminates the need for a physical key by making the chassis lockable through software and a password. You can also lock and unlock the chassis remotely over the network. The Sensor Kit detects when the access panel has been removed.	
Rear Port Control Cover	Yes, locks rear IO cables to prevent cable theft	
Serial, Parallel, USB, Audio, Network, Enable/Disable Port Control	Yes, enables or disables serial, USB, audio, and network ports	
Removable Media Write/Boot Control	Yes, prevents ability to boot from removable media on supported devices (and can disable writes to media)	
Power-On Password	Yes, prevents an unauthorized person from booting up the workstation	
Setup Password	Yes, prevents an unauthorized person from changing the workstation configuration	
3.3V Aux Power LED on System PCA	Yes	
NIC LEDs (integrated) (Green & Amber)	Yes	
CPUs and Heatsinks	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less	
Power Supply Diagnostic LED	Yes	
Front Power Button	Yes, ACPI multi-function	
Front Power LED	Yes, blue (normal), red (fault)	
Front Hard Drive Activity LED	Yes, green	
Front ODD Activity LED	Yes	
Internal Speaker	Yes	
System/Emergency ROM Flash Recovery	Recovers corrupted system BIOS.	
Cooling Solutions	Air cooled forced convection	
Power Supply Fans	92 mm x 92 mm x 25 mm 4-wire PWM (non-serviceable)	
CPU Heatsink Fan	Mainstream (<=95W): 92 mm x 92 mm x 25 mm 4-wire PWM	
Chassis Fan	92 mm x 92mm x 25 mm 4-wire PWM	
Memory Heatsink Fan	No	
HP Advanced System Diagnostics Offline Edition	HP System Advanced Diagnostics utility can be invoked by pressing F2 at POST, and enables you to perform testing and to view critical computer hardware and system software configuration information. HP Advanced System Diagnostics is provided on systems shipped with Windows and available as a download from HP Support.	
Access Panel Key Lock	No	



ACPI-Ready Hardware	Advanced Configuration and Power Management Interface (ACPI).
	 Allows the system to wake from a low power mode. Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
Integrated Chassis Handles	No; optional Optical Bay Handle available.
Power Supply	Requires T15 Torx or flat blade screwdriver
PCI Card Retention	Yes, rear (all), middle (optional), front (full-length cards with extender)
Flash ROM	Yes
Diagnostic Power Switch LED on board	Yes
Clear Password Jumper	Yes
Clear CMOS Button	Yes
CMOS Battery Holder	Yes
DIMM Connectors	Yes

BIOS	
BIOS 32-bit Services	Standard BIOS 32-bit Service Directory Proposal v0.4
PCI 3.0 Support	Full BIOS support for PCI Express through industry standard interfaces.
ATAPI	ATAPI Removable Media Device BIOS Specification Version 1.0.
BBS	BIOS Boot Specification v1.01.
WMI Support	WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications.
BIOS Boot Spec 1.01+	Provides more control over how and from what devices the workstation will boot.
BIOS Power On	Users can define a specific date and time for the system to power on.
ROM Based Computer Setup Utility (F10)	Review and customize system configuration settings controlled by the BIOS.
System/Emergency ROM Flash Recovery with Video	Recovers system BIOS in corrupted Flash ROM.
Replicated Setup	Saves BIOS settings to USB flash device in human readable file. Repsetup.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).
SMBIOS	System Management BIOS 2.7.1, for system management information.
Boot Control	Disables the ability to boot from removable media on supported devices.
Memory Change Alert	Alerts management console if memory is removed or changed.
Thermal Alert	 Monitors the temperature state within the chassis. Three modes: NORMAL - normal temperature ranges. ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown. SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.
Remote ROM Flash	Provides secure, fail-safe ROM image management from a central network console.

System rechnical s	Specifications				
ACPI (Advanced Configuration and Power Management Interface)	Allows the system to enter and resume from low power modes (sleep states). Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system. Supports ACPI 2.0 for full compatibility with 64-bit operating systems.				
Ownership Tag	A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.				
Remote Wakeup/Remote Shutdown	System administrators can power on, restart, and power off a client computer from a remot location.				
ASF 2.0 Compliant	No.				
Instantly Available PC (Suspend to RAM - ACPI sleep state S3)	Allows for very low power consumption with quick resume time.				
Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)	Allows a new or existing system to boot over the network and download software, including the operating system.				
ROM revision levels	Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.				
System board revision level	Allows management SW to read revision level of the system board. Revision level is digitally encoded into the HW and cannot be modified.				
Start-up Diagnostics (Power-on Self-Test)	Assesses system health at boot time with selectable levels of testing.				
Auto Setup when new hardware installed	System automatically detects addition of new hardware.				
Keyboard-less Operation	The system can be booted without a keyboard.				
Localized ROM Setup	Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings.				
Asset Tag	Enables the user or IT administrator to set a unique tag string in non-volatile memory.				
Per-slot Control	Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually.				
Adaptive Cooling	Control parameters are set according to detected hardware configuration for optimal acoustics.				
Pre-boot Diagnostics	(Pre-video) critical errors are reported via beeps and blinks on the power LED.				
Intel® Active Management Technology (AMT)	AMT 8.0; Allows workstation status to be monitored on a remote console				
Digitally and Cryptographically Signed BIOS	Helps to prevent the installation of unauthorized versions of a BIOS (a rogue BIOS) from a virus, malware, or other code that could lead to compromised system security, data access, physical service, or even system board replacement.				
Master Boot Record Protection	A feature in the HP BIOS that prevents changes and/or infections to the Master Boot Record. Useful in protecting from viruses				
Boot Block Emergency Recovery Mode (BIOS Recovery)	The HP BIOS offers a write-protected boot block ROM that provides recovery from a failed flashing of the computer BIOS. This special recovery mode prevents the system from becoming unusable or "bricked" when a BIOS update is interrupted.				
Industry Standard Specification Support					
Industry Standard	Revision Supported by the BIOS				
ACPI	Advanced Configuration and Power Management Interface, Version 2.0c				
<i></i>					

System Technical Specifications

ASF	Alert Standard Format Specification, Version 2.0		
ATA (IDE)	AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b		
CD Boot	"El Torito" Bootable CD-ROM Format Specification Version 1.0		
EDD	- Enhanced Disk Drive Specification Version 1.1 - BIOS Enhanced Disk Drive Specification Version 3.0		
EHCI	Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0		
PCI	PCI Local Bus Specification, Revision 2.3 PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0, Draft .7		
PCI Express	PCI Express Base Specification, Revision 2.0; PCI Express Base Specification, Revision 3.0.		
РММ	POST Memory Manager Specification, Version 1.01		
SATA	 Serial ATA Specification, Revision 1.0a Serial ATAII: Extensions to Serial ATA 1.0, Revision 1.0a Serial ATAII Cables and Connectors Volume 2 Gold SATA-IO SATA Revision 3.0 Specification 		
SPD	PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2B		
TPM	Trusted Computing Group TPM Specification Version 1.2		
USB	Universal Serial Bus Revision 1.1 Specification Universal Serial Bus Revision 2.0 Specification Universal Serial Bus Revision 3.0 Specification		
UEFI	UEFI 2.3.1		

Social and Environmental Responsibility

Occidi alla Elivii	
	 This product has received or is in the process of being certified to the following approvals and mabe labeled with one or more of these marks: ENERGY STAR® (energy-saving features available on selected configurations -Windows only) US Federal Energy Management Program (FEMP) China Energy Conservation Program (CECP)
	IT ECO declaration
Batteries	The battery in this product complies with EU Directive 2006/66/EC Battery size: CR2032 (coin cell) Battery type: Lithium Metal
	 Mercury greater than 5ppm by weight Cadmium greater than 10ppm by weight Lead greater than 40 ppm by weight.
Restricted Material Usage	This product meets the material restrictions specified in HP's General Specification for the the Environment: http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf

Hewlett-Packard is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis.

This product is brominated flame retardant and polyvinyl chloride free (BFR/PVC-free); meeting the evolving definition of "BFR/PVC-free" as set forth in the "iNEMI Position Statement on the 'Definition of Low-Halogen Electronics (BFR/CFR/PVC-Free)." Plastic parts contain <1,000 ppm (0.1 percent) of bromine (if the Br source is from BFRs) and <1,000 ppm (0.1 percent) of chlorine (if the CI source is from CFRs or PVC or PVC copolymers). All printed circuit board (PCB) and



System Technical Specifications

	substrate laminates contain bromine/chlorine total <1,500 ppm (0.15 percent) with a maximum chlorine of 900 ppm (0.09 percent) and maximum bromine being 900 ppm (0.09 percent). Service parts after purchase may not be BFR/PVC-free. Exceptions to this claim that may be shipped w the product include the power cord, keyboard, mouse and video adapters which may not be BFR/PVC-free.		
Packaging	This product meets the packaging requirements specified in HP's General Specification for the Environment. http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf		
	Design packaging materials for ease of disassembly.		
	 Maximize the use of post-consumer recycled content materials in packaging materials. Use readily recyclable packaging materials such as paper and corrugated materials. Reduce size and weight of packages to improve transportation fuel efficiency. 		
Packaging Materials			
Internal	EPE - Expanded Polyethylene, Polyethylene low density foam.		
	The EPE - Expanded Polyethylene packaging material is made from 100% recycled content		
	The Polyethylene low density foam packaging material is made from 100% recycled content		
External	Corrugated Carton.		
	The Corrugated Carton packaging material is made from 100% recycled content.		

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Intel Active
Management
Technology (AMT)

An advanced set of remote management features and functionality which provides network administrators the latest and most effective tools to remotely discover, heal, and protect network client systems regardless of the system's health or power state. AMT 8.0 includes the following advanced management functions:

- Power Management (on, off, reset)
- Hardware Inventory (includes BIOS and firmware revisions
- Hardware Alerting
- Agent Presence
- System Defense Filters
- SOL/IDER
- Cisco NAC/SDN Support
- ME Wake-on-LAN
- DASH 1.1 compliance
- IPv6 Support
- Fast Call for Help a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection
- Remote Scheduled Maintenance pre-schedule when the PC connects to the IT or service provider console for maintenance. Remote PCs can get required patches, be inventoried, etc by connecting to their IT console or Service Provider when it's convenient
- Remote Alerts automatically alert IT or service provider if issues arise
- Access Monitor Provides oversight into Intel® AMT actions to support security requirements
- PC Alarm Clock
- Microsoft NAP Support
- Host Base set-up and configuration
- Management Engine (ME) firmware roll back
- Wireless AMT functionality on Desktop (WoDT)
- Enhanced KVM resolution

Intel® vPro™ Technology

The HP Z220 workstations support Intel vPro technology when purchased with a vPro technology capable CPU: Intel® Xeon® processor E3-1200v2 family or 3rd Generation Intel Core i5/i7 processors with Intel VT and Intel TXT technology

Remote Manageability Software Solutions

Visit: http://www.hp.com/go/easydeploy

System Software Manager Visit: http://www.hp.com/go/ssm



System Technical Specifications

Service, Support, and Warranty

- Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories by email to customers, based on a user-defined profile.
- PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition.
- Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support.



Stable & Consistent Offerings

As part of its commitment to hardware, software, and solution innovation, HP is proud to introduct this breakthrough platform configuration stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chosen set of hardware and software designed and tested to work with all HP Z Workstation platforms through their end of life These components and their corresponding HP Workstation platform compatibility are outlined in this section. HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers-no special programs, no additional cost-no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be all to buy that same configuration throughout the lifecycle of the product.

Processors	Product #	Offering			
	A8Y07AV	Intel® Xeon® processor E3-1280v2, 3.6/4.0GHz, 69W, 8 MB cache, 1600 MHz memory, Quad-Core, HT, featuring Intel® vPro Technology			
	A8Y04AV	Intel® Xeon® processor E3-1240v2, 3.4/3.8GHz, 69W, 8 MB cache, 1600 MHz memory, Quad-Core, HT, featuring Intel® vPro Technology			
	A8Y02AV	Intel® Xeon® processor E3-1225v2, 3.2/3.6GHz, 77W, 8 MB cache, 1600 MHz memory, Quad-Core, no HT, Intel® HD Graphics P4000, featuring Intel® vPro Technology			
Hard Drives	Product #	Offering			
	A8X40AV	1TB 7200 RPM SATA 6G 1st HDD			
	A8X52AV	1TB 7200 RPM SATA 6G 2nd HDD			
	A8X61AV	1TB 7200 RPM SATA 6G 3rd HDD			
	A8X39AV	500GB 7200 RPM SATA 6G 1st HDD			
	A8X51AV	500GB 7200 RPM SATA 6G 2nd HDD			
	A8X60AV	500GB 7200 RPM SATA 6G 3rd HDD			
Graphics	Product #	Offering			
	A7U41AV	NVIDIA NVS 310 512MB Graphics			
	A7U42AV	NVIDIA NVS 310 512MB 2nd Graphics			
Memory	Product #	Offering			
	A8Y23AV	16GB DDR3-1600 ECC (4x4GB) RAM			
	B4Y02AV	12GB DDR3-1600 ECC (2x4GB+2x2GB) RAM			
	A8Y22AV	8GB DDR3-1600 ECC (2x4GB) RAM			
	A8Y21AV	8GB DDR3-1600 ECC (4x2GB) RAM			
	A8Y20AV	4GB DDR3-1600 ECC (2x2GB) RAM			
	A8Y19AV	2GB DDR3-1600 ECC (1x2GB) RAM			
Optical and Remova	bleProduct #	Offering			
Storage	A8X92AV	16X SuperMulti DVDRW SATA 1st ODD			
	A8X95AV	16x SuperMulti DVDRW SATA 2nd ODD			
Operating Systems	Product #	Offering			
	A3J50AV	Genuine Windows® 7 Professional 64-bit			



Technical Specifications - Processors

Processors

Intel Xeon processor E3-1290v2, 3.70 GHz/4.1GHz, 87W, 8 MB cache, 1600 MHz memory, Quad-Core, HT, featuring Intel vPro Technology

Intel® Xeon® processor E3-1280v2, 3.6/4.0 GHz, 69W, 8 MB cache, 1600 MHz memory, Quad-Core, HT, featuring Intel® vPro Technology

Intel® Xeon® processor E3-1270v2, 3.5/3.9 GHz, 69W, 8 MB cache, 1600 MHz memory, Quad-Core, HT, featuring Intel® vPro Technology

Intel® Xeon® processor E3-1245v2, 3.4/3.8 GHz, 77W, 8 MB cache, 1600 MHz memory, Quad-Core, HT, Intel® HD Graphics P4000, featuring Intel® vPro Technology

Intel® Xeon® processor E3-1240v2, 3.4/3.8 GHz, 69W, 8 MB cache, 1600 MHz memory, Quad-Core, HT, featuring Intel® vPro Technology

Intel® Xeon® processor E3-1230v2, 3.3/3.7 GHz, 69W, 8 MB cache, 1600 MHz memory, Quad-Core, HT, featuring Intel® vPro Technology

Intel® Xeon® processor E3-1225v2, 3.2/3.6 GHz, 77W, 8 MB cache, 1600 MHz memory, Quad-Core, no HT, Intel® HD Graphics P4000, featuring Intel® vPro Technology

Intel Core i7-3770 processor, 3.4/3.9 GHz, 77W, 8 MB cache, 1600 MHz memory, Quad-Core, HT, Intel HD Graphics 4000, featuring Intel vPro Technology

Intel Pentium G640 processor, 2.8 GHz, 65W, 3MB cache, 1066 MHz memory, Dual-Core, Intel HD Graphics



Technical Specifications - Hard Drives

SATA (Serial ATA) Hard300GB SATA 10K rpm Drives for HP SFF in 3.5" Frame HDD

Workstations

Capacity 300,069,052,416 bytes

Height 1 in; 2.54 cm

Width Media Diameter 2.5 in; 6.36 cm

Physical Size 4 in; 10.17 cm

4.4 ms

Interface Serial ATA (3.0 Gb/s), Native Command

Queuing enabled

Synchronous Transfer Up to 300 MB/s

Rate (Maximum)

Cache 16 MB

Seek Time (typical Single Track 0.7 ms (maximum)

reads, includes controller Average overhead, including

settling) Full Stroke

Full Stroke 9.5 ms

Rotational Speed 10,000 rpm **Logical Blocks** 586,072,368

Operating Temperature41° to 131° F (5° to 55° C)

1TB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity 1 Terabyte (1000 GB)

Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm

Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer Up to 600 MB/s

Rate (Maximum)

Buffer 32MB

Seek Time (typical
reads, includes controller
overhead, including
settling)Single Track
Average2 msAverage
Full Stroke11 ms21 ms

Rotational Speed 7,200 rpm **Logical Blocks** 1,953,525,168

Operating Temperature41° to 131° F (5° to 55° C)

500GB SATA 7200 rpm Capacity 6Gb/s 3.5" HDD

Capacity 500GB

Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer Up to 600MB/s

Rate (Maximum)

Buffer 16MB

Seek Time (typical Single Track 2 ms reads, includes controller overhead, including Full Stroke 2 ms

Rotational Speed 7,200 rpm

Logical Blocks 976,773,168

Operating Temperature41° to 131° F (5° to 55° C)



Technical Specifications - Hard Drives

250GB SATA 7200 rpm Capacity

6Gb/s 3.5" HDD

250 GB Height 1 in; 2.54 cm

Width **Media Diameter** 3.5 in: 8.9 cm **Physical Size** 4 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer Up to 600MB/s

Rate (Maximum)

Buffer 8 MB

Seek Time (typical **Single Track** 2 ms reads, includes controller Average 11 ms overhead, including **Full Stroke** 21 ms settling)

Rotational Speed 7,200 rpm **Logical Blocks** 488,397,168

Operating Temperature41° to 131° F (5° to 55° C)

2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity 2TB

1 in: 2.54 cm Height

Width **Media Diameter** 3.5 in; 8.9 cm **Physical Size** 4 in: 10.17 cm

Interface Serial ATA (6.0 Gb/s), NCQ Enabled

Synchronous Transfer Up to 600MB/s

Rate (Maximum)

Buffer 64MB

Seek Time (typical **Single Track** 1.0 ms reads, includes controller **Average** 11 ms overhead, including **Full Stroke** 18 ms settling)

Rotational Speed 7.200 rpm **Logical Blocks** 3,907,029,168

Operating Temperature41° to 131° F (5° to 55° C)

HP Solid State Drives HP 160GB SATA SSD

(SSDs) for Workstations Capacity

Width **Media Diameter** NaN in; NaN cm

160GB

Physical Size 2.5 in; 6.36 cm

SATA Interface Synchronous Transfer 3Gb/s

Rate (Maximum)

Operating Temperature 32° to 158° F (0° to 70° C)

HP 300GB SATA SSD Capacity

> Width **Physical Size** 2.5 in; 6.36 cm

300GB

SATA Interface Synchronous Transfer 3Gb/s

Rate (Maximum)

Operating Temperature32° to 158° F (0° to 70° C)



Graphics Card

Technical Specifications - Graphics

NVIDIA NVS 300 512MB Form Factor

Graphics Controller

NVIDIA NVS 300 Graphics Board

Bus Type PCI Express x16, Generation 2.0

Memory 512 MB GDDR3 SDRAM unified graphics memory

Connectors DMS-59

Includes DMS-59 to Dual DVI-I adapter

2.7 inches (H) x 5.7 inches (L), Half-Height

DMS-59 to Dual DisplayPort adapter and DMS-59 to Dual VGA adapte

available as an option

DMS-59 to Dual DisplayPort adapter required for HP ZR30w Display

Maximum Resolution DVI: two digital displays up to 1920 x 1200

DisplayPort: two digital displays up to 2560 x 1600 VGA: two analog displays up to 1920 x 1080

Image Quality Features

Display Output This

This card support up to two displays:

 Drives DVI enabled digital displays at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking

 Drives DisplayPort enabled digital displays at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking (through optional DMS-59 to DisplayPort adapter)

 Drives VGA enabled analog displays at resolutions up to 1920 x 1080 (through optional DMS-59 to VGA adapter)

Supported Graphics

APIs

OGL 3.3 DirectX 10.1

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit)
Genuine Windows Vista Business (64-bit and 32-bit)
Microsoft Windows XP Professional (64-bit and 32-bit)
Red Hat Enterprise Linux(RHEL) 5 Desktop/Workstation
Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation
SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from:

ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption <18 Watts

NVIDIA NVS 310 512MB Form Factor Low Profile:

Graphics Card

2.713 inches in height × 6.150 inches in length

Graphics Controller NV

NVIDIA NVS 310

Bus Type

PCI Express x16, 2.0 compliant

Memory Size: 512MB DDR3

Clock: 875Mhz

Memory Bandwidth: 14GB/s

Connectors 2 x DisplayPort 1.2

Maximum Resolution Up to 2560 x 1600 (digital display) per display.

Image Quality Features See Display Output section.

The following video formats are supported:

MPEG2



Technical Specifications - Graphics

- MPEG4 Part 2 Advanced Simple Profile
- H.264 SVC codec support
- Support for 3D Blu Ray
- VC1
- DivX version 3.11 and later
- MVC

A full range of video resolutions are supported including 1080p, 1080i, 720p, 480p and 480i. The NVS 310 GPU provides hardware acceleration for the computationally intensive parts of video processing as well as provides improved video playback speeds via faster decode and transcode.

Display Output

Up to 2 displays in the following configurations:

DisplayPort output:

- Drives two DisplayPort enabled digital display at resolutions up t 2560 × 1600 at 60 Hz with reduced blanking, when connected natively using the 2 DisplayPort connectors on the NVS 310 graphics card
- Supports 2 monitors up to resolution of 1920 × 1200 at 60 Hz wireduced blanking using DisplayPort 1.2 multi stream topology technology.

DVI-D output:

- Drives two digital display at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort to DVI-D single-link cable adaptors
- Drives two digital display at resolutions up to 2560× 1600 at 60 I with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors

HDMI output:

 NVS 310 is capable of driving two high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI cable adaptors

VGA display output:

Drives two analog display at resolutions up to 1920 × 1200 at 60
 Hz using DisplayPort to VGA cable adaptors

Shading Architecture Supported Graphics APIs Shader Model 5.0 DX11, OpenGL 4.1

Available Graphics Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or the latest HP qualified drivers are available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption

19.5 Watts



Technical Specifications - Graphics

Note The thermal solution used on this card is an active fan heatsink.

AMD FirePro V4900 1GB Graphics Card Form Factor Full height (4.37 in), half length (6.61 in)

Graphics Controller AMD FirePro™ V4900 Professional Graphics

Bus Type PCI Express™ x16, Generation 2.1

Momony 1GR GDDP5

Memory 1GB GDDR5

Connectors 2 DisplayPort, 1 dual link DVI Output, One DP to DVI adapter included Maximum Resolution Up to three digital displays at resolutions up to 2560 x 1600 @ 60Hz o

up to three analog displays, one at resolutions up to 2048 x 1536 @ 85Hz, plus two resolutions up to 1920 x 1200 @ 60Hz (165 MHz dot clock) Note: This card supports up to three displays with Windows 7,

Vista or Linux, and up to two displays on XP

RAMDAC

Image Quality Features Up to 3 independent outputs with ATI Eyefinity technology support

(More information at:

www.amd.com/us/products/technologies/eyefinity/). Full 30-bit display pipeline. Advanced video capabilities, including high fidelity gamma, color correction and scaling. Dedicated hardware (UVD2) for H.264, VC

1, and MPEG2 decode

NOTE: The use of more than two displays on Linux requires support fo

xrandr 1.2 or greater in the X server.

Supported graphics

APIs

DirectX 11 and OpenGL 4.1.

OpenCL 1.2
DirectCompute 11

Available graphics

drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or the latest HP qualified drivers

are available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

Power Consumption

Note

<75W

AMD Eyefinity technology can support multiple displays using a single enabled AMD FirePro™ professional graphics card; the number of supported displays varies by card model. Microsoft® Windows® 7, Windows Vista®, or Linux® is required in order to support more than 2 displays. Depending on the card model, native DisplayPort™ connecte and/or certified DisplayPort™ active or passive adapters to convert you monitor's native input to your card's DisplayPort™ or Mini-DisplayPort¹ connector(s) may be required. See www.amd.com/firepro for details.



Technical Specifications - Graphics

AMD FirePro V3900 1GB Graphics Card

Form Factor Full height, half length (full-height bracket included)

Graphics Controller AMD FirePro™ V3900 professional graphics

Bus Type PCI Express® x16, Generation 2.1

Memory 1GB DDR3 memory

2560x1600 per display (5120x1600 max. horizontal resolution) **Maximum Resolution**

Display Output 1 DisplayPort® 1.2

1 Dual-link DVI

Shading Architecture Shader Model 5.0

Supported Graphics OpenCL™ 1.1, DirectX® 11 and OpenGL 4.2

APIs

Available Graphics

Drivers

Genuine Windows® 7 Professional (64-bit and 32-bit) Genuine Windows Vista® Business (64-bit and 32-bit) Microsoft® Windows XP® Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Power Consumption

Note

AMD Eyefinity technology can support multiple displays using a single enabled AMD FirePro™ professional graphics card; the number of supported displays varies by card model. Microsoft® Windows® 7, Windows Vista®, or Linux® is required in order to support more than 2

displays. Depending on the card model, native DisplayPort™ connectc and/or certified DisplayPort™ active or passive adapters to convert you monitor's native input to your card's DisplayPort™ or Mini-DisplayPort¹ connector(s) may be required. See www.amd.com/firepro for details.

NVIDIA Quadro 600 1GB Graphics Card **Form Factor** 2.731" H x 6.6" L

> Single Slot Small Form Factor

Graphics Controller NVIDIA Quadro 600 Graphics Card

Bus Type PCI Express 2.0 x16 Memory 1 GB GDDR3

128-bit

Connectors 1 DVI-I output, 1DisplayPort output

One DP to DVI adapter included with card

DVI to VGA, DisplayPort to VGA and DisplayPort to DVI adapters

available as accessories

DisplayPort (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120Hz) Maximum Resolution

Dual-link DVI-I output (up to 2560 x 1600 @ 60Hz and 1920x1200 @

120Hz)

Shading Architecture Shader Model 5.0 OpenGL 4.0

Supported Graphics

DirectX 11

APIs

CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit)



Technical Specifications - Graphics

Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 3:

Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption 40 Watts

NVIDIA Quadro 410 512MB Graphics

Form Factor Low Profile:

2.713 inches × 5.7 inches, single slot

Graphics Controller

NVIDIA Quadro 410

Bus Type

PCI Express x16, 3.0 compliant

Size: 512MB DDR3 Memory Clock: 900MHz

Memory Bandwidth: 14GB/s

Connectors One dual-link DVI-I connector

One DisplayPort connector

Maximum Resolution

Up to 2560 x 1600 (digital display) per display.

RAMDAC 400 MHz integrated RAMDAC

Display Output Maximum resolution over DisplayPort: 2560 × 1600 × 32 bpp at 60 Hz

(reduced blanking)

Maximum resolution over DVI port: 2560 × 1600 × 32 bpp at 60 Hz

(reduced blanking)

Maximum resolution over VGA (through DVI to VGA cable): 2048 × 153

× 32 bpp at 85 Hz

Shading Architecture

Supported Graphics

APIs

Shader Model 5.0 DX11, OpenGL 4.2

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit)

Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or the latest HP qualified drivers

are available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com



Technical Specifications - Graphics

AMD FirePro V5900 2GB Graphics Card

Form Factor Full-height, full length, single slot

Graphics Controller AMD FirePro™ V5900 Professional Graphics

Bus Type PCI Express™ x16, Generation 2.1

Memory 2GB GDDR5

Connectors 2 x Display Port 1.2

1 x Dual-link DVI

One DP to DVI adapter included with card

Maximum Resolution 2560 x 1600

Display Output Up to 3 simultaneous displays (using AMD Eyefinity with Windows 7 c

Linux)

Shading Architecture Shader Model 5.0

Supported Graphics

APIs

DirectX 11 and OpenGL 4.1

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Power Consumption

Note

< 75W

AMD Eyefinity technology can support multiple displays using a single enabled AMD FirePro™ professional graphics card; the number of supported displays varies by card model. Microsoft® Windows® 7, Windows Vista®, or Linux® is required in order to support more than 2 displays. Depending on the card model, native DisplayPort™ connecte and/or certified DisplayPort™ active or passive adapters to convert you monitor's native input to your card's DisplayPort™ or Mini-DisplayPort¹ connector(s) may be required. See www.amd.com/firepro for details.

NVIDIA Quadro 2000 1GB Graphics Card

Form Factor 4.376" H x 7" L

Single Slot

Graphics Controller

NVIDIA Quadro 2000 Graphics Card

Bus Type

PCI Express 2.0 x16

Memory

1 GB GDDR5

128-bit

Connectors

1 DVI-I output, 2 DisplayPort outputs
One DP to DVI adapter included with card

DVI to VGA, DisplayPort to VGA and DisplayPort to DVI adapters

available as accessories

Maximum Resolution

Dual DisplayPort (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120H: Dual-link DVI-I output (up to 2560 x 1600 @ 60Hz and 1920x1200 @

120Hz)

Image Quality Features

• Up to 16K x16K texture and render processing

Transparent multisampling and super sampling

• 16x angle independent anisotropic filtering

128-bit floating point performance

32-bit per-component floating point texture filtering and blending

Support for any combination of two connected displays

• DisplayPort 1.1a, HDMI 1.3a, and HDCP support

NVIDIA® 3D Vision™ technology, 3D DLP, Interleaved, and othe



Technical Specifications - Graphics

3D stereo format support

- Full OpenGL quad buffered stereo support
- Underscan/overscan compensation and hardware scaling
- NVIDIA® nView® multi-display technology

Shading Architecture

Shader Model 5.0

Supported Graphics

OpenGL 4.1 DirectX 11

APIs

CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 3:

bit)

Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption 62 Watts

NVIDIA Quadro 4000 2GB Graphics Card

Form Factor 4.376" H x 9.50" L

Single Slot

Graphics Controller

NVIDIA Quadro 4000 Graphics Card

Bus Type Memory PCI Express 2.0 x16

2 GB GDDR5 256-bit

Connectors

1 DVI-I output, 2 DisplayPort outputs;

One DP to DVI adapter included with card

DVI to VGA, DisplayPort to VGA and DisplayPort to DVI (single-link c

dual-link) adapters available as accessories (Optional stereo bracket available from 3rd party)

Maximum Resolution

Dual DisplayPort (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120H: Dual-link DVI-I output (up to 2560 x 1600 @ 60Hz and 1920x1200 @

120Hz)

RAMDAC

400 MHz integrated RAMDAC

Image Quality Features

- Up to 16K x16K texture and render processing
- Transparent multisampling and super sampling
- 16x angle independent anisotropic filtering
- 128-bit floating point performance
- 32-bit per-component floating point texture filtering and blending
- Support for any combination of two connected displays
- DisplayPort 1.1a, HDMI 1.3a, and HDCP support
- NVIDIA 3D Vision™ technology, 3D DLP, Interleaved, and other 3D stereo format support
- Full OpenGL quad buffered stereo support
- Underscan/overscan compensation and hardware scaling
- NVIDIA nView® multi-display technology



Technical Specifications - Graphics

Shading Architecture Supported Graphics

APIs

Shader Model 5.0 OpenGL 4.0

DirectX 11

CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 3:

bit)

Red Hat Enterprise Linux (RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from:

ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption

AMD FirePro V7900 2GB Graphics Card Form Factor

Graphics Controller

Full height, full length, single slot

AMD FirePro™ V7900 Professional Graphics

Bus Type

PCI Express™ x16, Generation 2.1

Memory

2GB GDDR5
4 x DisplayPort 1.2

Connectors

Two DP to DVI adapters included with card

Maximum Resolution

Display Output

2560 x1600

142 Watts

Up to 4 simultaneous displays (using AMD Eyefinity with Windows 7 c

Linux)

Shading Architecture

Supported Graphics

APIs

Shader Model 5.0

DirectX 11 and OpenGL 4.1

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Power Consumption

Note

< 150W

AMD Eyefinity technology can support multiple displays using a single enabled AMD FirePro™ professional graphics card; the number of supported displays varies by card model. Microsoft® Windows® 7, Windows Vista®, or Linux® is required in order to support more than 2 displays. Depending on the card model, native DisplayPort™ connecte and/or certified DisplayPort™ active or passive adapters to convert you monitor's native input to your card's DisplayPort™ or Mini-DisplayPort¹ connector(s) may be required. See www.amd.com/firepro for details.



Technical Specifications - Multimedia and Audio Devices

HP Thin USB Powered Frequency Response (- FO to 20kHz

Speakers 3dB, 24-bit/96kHz input)

Dimensions (H x W x D) Speakers: 14.52 x 9.50 x 2.45 cm (5.72 x 3.74 x 0.96 in) per speaker



Technical Specifications - Optical and Removable Storage

HP DVD-ROM Drive Description 5.25-inch, half-height, tray-load

Mounting Orientation Either horizontal or vertical

Interface Type SATA/ATAPI

Dimensions (WxHxD) 15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)

Disc Capacity DVD-ROM Single layer: Up to 4.7 GB Double layer: Up

8.5 GB

Access Times DVD-ROM Single Layer < 140 ms (typical)

CD-ROM Mode 1 < 125 ms (typical)

Full Stroke DVD < 250 ms (seek)

Full Stroke CD < 210 ms (seek)

Power Source SATA DC power receptacle

DC Power $5 \text{ VDC} \pm 5\%$ -100 mV ripple p-pRequirements $12 \text{ VDC} \pm 5\%$ -200 mV ripple p-p

DC Current 5 VDC - <1000 mA typical, < 1600 mA

maximum

12 VDC - < 600 mA typical, < 1400 mA

41° to 122° F (5° to 50° C)

maximum

10% to 90%

86° F (30° C)

Operating

Environmental (all conditions non-condensing)

Temperature

Relative Humidity Maximum Wet Bulb

Temperature

Operating Systems Supported Windows 7 Professional 32-bit and 64-bit,

Windows Vista Business 64*, Windows Vist Business 32*, Windows Vista Home Basic

32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. Red Hat Enterprise Linux(RHEL) WS4**, 5, 6

Desktop/Workstation,

Removed reference to "Novell" because of acquisition and changed product reference to "SUSE Linux Enterprise Desktop 10 & 11", No driver is required for this device. Native support is provided by the operating system.

HP DVD+/-RW Drive

Description 5.25-inch, half-height, tray-load

Mounting Orientation Either horizontal or vertical

Interface Type SATA/ATAPI

Dimensions (WxHxD) 15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)

Disc Formats DVD-RAM

DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW

Disc Capacity DVD-ROM 8.5 GB DL or 4.7 GB standard

Full Stroke DVD < 250 ms (seek) Full Stroke CD < 210 ms (seek)



Technical Specifications - Optical and Removable Storage

Maximum Data Transfer Rates	CD ROM Read	CD-ROM, CD-R Up to 40X CD-RW Up to 32X		
	DVD ROM Read	DVD-RAM	Up to 12X	
		DVD+RW	Up to 8X	
		DVD-RW	Up to 8X	
		DVD+R DL	Up to 8X	
		DVD-R DL	Up to 8X	
		DVD-ROM	Up to 16X	
		DVD-ROM DL	Up to 8X	
		DVD+R	Up to 16X	
		DVD-R	Up to 16X	
Power	Source	SATA DC power re	eceptacle	
	DC Power Requirements	5 VDC ± 5%-100 mV ripple p-p 12 VDC ± 5%-200 mV ripple p-p		
	DC Current	5 VDC -1000 mA typical, 1600 mA maxir 12 VDC -600 mA typical, 1400 mA maxir		
Operating	Temperature	41° to 122° F (5° to 50° C)		
Environmental (all	Relative Humidity	10% to 90%		
conditions non- condensing)	Maximum Wet Bulb Temperature	86° F (30° C)		
	Operating Systems Supported	Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64*, Windows V Business 32*, Windows Vosta Home Basid 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. Red Hat Enterprise Linux(RHEL) WS4**, 5 Desktop/Workstation SUSE Linux Enterprise Desktop 10 & 11 No driver is required for this device. Native support is provided by the operating system HP SATA SuperMulti DVD Writer Drive, Refeasy Media Creator software, Intervideo WinDVD Software, installation guide, and DVD+R media.		
	Kit Contents			

HP Blu-Ray Writer

Description5.25-inch, half-height, tray-loadMounting OrientationEither horizontal or vertical

Interface Type SATA

Dimensions (WxHxD) 15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)

Disc Formats BD-ROM BD-R

BD-R BD-RE DVD-RAM DVD+R DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW



Technical Specifications - Optical and Removable Storage

Disc Capacity	DVD-ROM	8.5 GB DL or 4.7 GB standard		
	Blu-ray	50 GB DL or 25 GB standard		
	Full Stroke DVD	< 250 ms (seek)		
	Full Stroke CD	< 210 ms (seek)		
	Blu-ray	Blu-ray		
	Startup Time (Time to	BD-ROM (SL/DL)	25S / 28S	
	drive ready from tray	BD-R (SL/DL)	25S / 28S	
	loading)	BD-RE (SL/DL)	25S / 28S	
		DVD-ROM (SL/DL)	18S / 18S	
		DVD-R (SL/DL)	25S / 25S	
		DVD-RW	25S	
		DVD+R (SL/DL)	25S / 25S	
		DVD+RW	25S	
		DVD-RAM	45S	
		CD-ROM	45S	
Maximum Data	CD ROM Read	CD-ROM	Up to 40X	
Transfer Rates		CD-R	Up to 40X	
	DVD DOM Decad	CD-RW	Up to 40X	
	DVD ROM Read	DVD-RAM	Up to 5X	
		DVD+RW	Up to 10X	
		DVD-RW	Up to 10X	
		DVD+R DL	Up to 8X	
		DVD-R DL	Up to 8X	
		DVD-ROM	Up to 16X	
		DVD-ROM DL	Up to 8X	
		DVD+R	Up to 12X	
	Plu Pov	DVD-R	Up to 12X	
	Blu-Ray	BD-ROM DI	Up to 6X	
		BD-ROM DL BD-R	Up to 4.8X	
		BD-R DL	Up to 6X	
		BD-R DL BD-R	Up to 4.8X Up to 6X	
		BD-RE SL/DL	Up to 4.8X	
Power	Source	SATA DC power rece	•	
1 OWEI	DC Power	5 VDC ± 5%-100 mV	•	
	Requirements	12 VDC ± 10%-100 m		
	DC Current	5 VDC -900 mA typical, 1200 mA maxin 12 VDC -1000 mA typical, 1600 mA ma		
Operating	Temperature	41° to 122° F (5° to 50° C)		
Environmental (all	Relative Humidity	15% to 80%		
conditions non- condensing)	Maximum Wet Bulb Temperature	86° F (30° C)		
	Operating Systems	Windows 7 Profession		
	Supported	Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*.		



Red Hat Enterprise Linux(RHEL) WS4**, 5, (

Desktop/Workstation,

Technical Specifications - Optical and Removable Storage

SUSE Linux Enterprise Desktop 10 & 11

* No driver is required for this device. Native support is provided by the operating system.

** RHEL WS4 not supported on

Z200/Z200SFF

Kit Contents HP Blue Laser RW Drive, Roxio Easy Media

Creator software, Intervideo WinDVD

Software, installation guide.

Disclaimer As Blu-Ray is a new format containing new technologies, certain disc,

digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-Ray titles to play, the may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this

workstation.

HP 22-in-1 Media Card Description

Reader

The Media Card Reader device uses the same physical form factor and mounting as a Floppy Disk Drive. The device connects to a 2x5 two-channel USB header on the motherboard of the system. There is no USB controller card provided. Please see the Disc Formats section below for a list of flash memory card formats that are supported.

Mounting Orientation The Media Card Reader can be mounted in a dedicated Floppy Drive

bay (if the chassis provides one) or in an appropriate Optical Bay

adapter. It will operate in any orientation.

Interface Type USB 2.0 (one channel dedicated to the separate USB port; one channel

dedicated to the flash memory card slots)

Dimensions (WxHxD) 12

Disc Formats

124.5 x 101.6 x 25.4 mm (4.9 x 4.0 x 1.0 in)

xD-Picture Micro SD

Micro SDHC

SD SDHC SDXC Mini SD Mini SDHC

MultiMediaCard (MMC)

Reduced Size MultiMediaCard (RS MMC)

MultiMedia Card 4.2 (MMC Plus, including MMC Plus HC)

Reduced Size MultiMedia Card 4.2 (MMC Mobile, including MMC Mob

HC)

CompactFlash Card Type I CompactFlash Card Type II

MicroDrive

Memory Stick (MS)

MagicGate Memory Stick (MG) MagicGate Memory Stick Duo

Memory Stick Select

Memory Stick Duo (MS Duo) Memory Stick PRO (MS PRO)

Memory Stick PRO Duo (MS PRO Duo)

Memory Stick PRO-HG Duo

Two additional formats are usable with adapters (not supplied):

MMC Micro



Technical Specifications - Optical and Removable Storage

Memory Stick Micro (M2)



Technical Specifications - Controller Cards

HP IEEE 1394b
FireWire PCle Card

Data Transfer Rate Supports up to 800 Mbps

Devices Supported IEEE-1394 compliant devices

Bus Type PCIe card full height PCIe slots

Ports Two IEEE-1394b bilingual 9-Pin Connector (Rear)

50° to 131° F (10° to 55° C)

Internal Connectors One 10-Pin header Custom Connector

System Requirements Windows 7 Professional 32-bit and 64-bit, Microsoft® Windows® XP Professional, Windows XP Home, Windows Vista, SLED 11 and RHEL

6. Intel Pentium® G series or higher processor, 128-MB RAM, 1-GB Hard Drive, CD-ROM drive, built in sound system, Available PCIe slot.

Temperature – Operating

Operating
Temperature – Storage –22° to 140° F (–30° to 60° C)

Relative Humidity –

Operating

20% to 80%

Compliances

FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-

1998 STD, Taiwan BSMI CNS13438, Korea MIC

Operating Systems

Supported

Windows 7 Professional 32-bit and 64-bit, Windows Vista® Business 32-bit and 64-bit, Windows® XP Professional, XP Professional 64-bit,

RHEL 6 and SLED 11.

HP USB 3.0 2x2 Port SuperSpeed PCle x1 Card Dimensions (HxD) TBD

Ports 2 External, 2 internal

Operating Systems Supported

Microsoft Windows 7, Windows Vista*, Windows XP Professional (32-l and 64-bit); Red Hat Enterprise Linux 6, SUSE Linux Enterprise

Desktop 11

Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: http://www.windowsvista.com/upgradeadvisor.

For Windows Vista system requirements, visit: http://www.windowsvista.com/systemrequirements.

Kit Contents

I/O and Security Software and Documentation CD with software drivers and documentation, HP SuperSpeed USB 3.0 PCIe x1 card (with full-height expansion bracket attached), SATA to SATA split power extension cable, Low profile expansion bracket to replace the full-height expansion bracket required on some computer models and HP

SuperSpeed USB 3.0 PCIe x1 Card Quick Setup.

Regulatory Approvals and registrations

FCC 15B, CE EN55022+ EN55024, VCCI, CISPR 22 AS/NZS CISPR 22, LCIE CB service(ITE/AV) IEC 60950-1, Korea EMC, UL USB-IF

0.21 lb (95.0 g)

Weight Warranty

The HP USB 3.0 2x2 Port Super Speed PCIe x1 Card has either a one year limited warranty or the remainder of the warranty of the HP production which it is installed. Technical support is available seven days a

week, 24 hours a day, by phone, as well as online support forums.

Certain restrictions and exclusions apply.

Technical Specifications - Networking and Communications

Integrated Intel 82579LM PCIe GbE Controller Connector RJ-45

Controller Intel 82579LM GbE platform LAN connect networking controller

Memory 24 KB FIFO packet buffer memory

Data Rates Supported 10/100/1000 Mbps

Compliance 802.1P, 802.1Q, 802.2, 802.3, 802.3ab, 802.3az, 802.3u

Bus Architecture PCI Express and SMBus

Data Transfer Mode PCIe-based interface for active state operation (S0 state) and SMBus

for host and management traffic (Sx low power state)

Power Requirement Requires 3.3V and 1.05V or just 3.3V with integrated regulators

Boot ROM Support Yes

Network Transfer Mode Full-duplex; Half-duplex (not supported for the 1000BASE-T transceiver

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Management Capabilities

WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, Advanced

cable diagnostic.

AMT 7.0 support

Intel Gigabit CT Desktop NIC Connector RJ-45

Controller Intel WG82574L Gigabit Ethernet Controller

Memory Integrated Dual 48K configurable transmit receive FIFO Buffers

Data Rates Supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802,1Q, 802.2, 802.3, 802.3AB and 802.3u compliant,

802.3x flow control

Bus Architecture PCI-E 1.0a

Data Path Width X1, 250 MB/s, Bi-directional interface

Data Transfer Mode Bus-master DMA

Hardware FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS

Certifications Mark for European Union

Power Requirement Aux 3.3V, 3.0 Watts in 1000base-T and 2.0 Watts in 100Base-T

Boot ROM Support Yes

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Operating Temperature32° to 131°F (0° to 55° C)
Operating Humidity 85% at 131° F (55° C)

Dimensions 12.1 x 5.7 x 2.0 cm (4.75 x 2.25 x 0.8 in)

Operating System Driver Support

Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64 Windows Vista Business 32, Windows XP Professional, Windows XP

x64.

Red Hat Enterprise Linux 4 (RHEL4.8 or newer)*, Red Hat Enterprise Linux 5 (RHEL5.3 or newer), Red Hat Enterprise Linux 6, SUSE Linux

Enterprise Desktop (SLED) 11

RHEL 4 and 5, SLED 10, are not supported on the Z220 CMT/SFF



Technical Specifications - Networking and Communications

Management Capabilities

Kit Contents

WOL, PXE, DMI, WFM 2.0

Capabilities

Intel Gigabit CT Desktop NIC, low profile bracket, CD containing Intel PROset II NIC drivers, quick install guide, product warranty statement

Broadcom (5761) NetXtreme Gigabit Ethernet Plus NIC Connector RJ-45

Controller Broadcom 5761 PCI-Express LAN Controller

Memory 8 MB NVRAM serial Flash

Data Rates Supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802.1Q, 802.2, 802.3, 802.3AB, 802.3u, and 802.3x

Bus Architecture PCI-Express

Data Path Width Single Channel PCI-Express

Data Transfer Mode Bus Master DMA

Hardware FCC class B, Canada and US NRTL Mark, C-Tick for Australia, BSMI **Certifications** for Taiwan, VCCI for Japan, MIC for Korea, GOST for Russia, UL listed

(E212044), European Union Notice (CE 0682)

Power Requirement 1.8W @ 3.3V

Boot ROM Support Yes
Network Transfer Mode Full-duplex

Half-duplex (not available for the 1000BASE-T transceiver)

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Operating Temperature 32° to 131°F (0° to 55° C)

Operating Humidity 131° F (55° C) with 5% to 95% non-condensing humidity **Dimensions** 7 cm x 10.5 cm (2.75 in x 4.13 in), low profile compatible

Operating System Driver Support

Windows 7 Professional 32-bit and 64-bit, Windows Vista 32-bit SP1, Windows Vista x64 SP1, Windows XP 32 bit professional, Windows XI

x64

Red Hat Enterprise Linux (RHEL) 5, 6; Novell SLED 10 & 11

Management Capabilities Kit Contents ACPI, WOL and DMI 2.0, PXE 2.0, WfM 2.0, Broadcom mgmt utility,

ASF2.0, DASH 1.0 and DASH 1.1 profiles
Broadcom NetXtreme Gigabit Ethernet Plus NIC, Broadcom NetXtreme

Gigabit Ethernet Plus NIC USB Cable Assembly, CD, drivers, quick

install guide, product warranty statement

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